

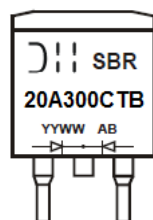
Marking Information



SBR20A300CT = Product Type Marking Code
 AB = Foundry and Assembly Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 14 = 2014)
 WW = Week (01 - 53)



SBR20A300CTFP = Product Type Marking Code
 AB = Foundry and Assembly Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 14 = 2014)
 WW = Week (01 - 53)



SBR20A300CTB = Product Type Marking Code
 AB = Foundry and Assembly Code
 YYWW = Date Code Marking
 YY = Last two digits of year (ex: 08 = 2008)
 WW = Week (01-52)

Maximum Ratings (Per Leg) (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	300	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _{RM}		
Average Rectified Output Current (Per Leg) (Total)	I _O	10 20	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	180	A
Peak Repetitive Reverse Surge Current (2μS-1KHz)	I _{RRM}	3	A
Isolation Voltage (ITO-220AB Only) From terminal to heatsink t = 3 sec.	V _{AC}	2,000	V

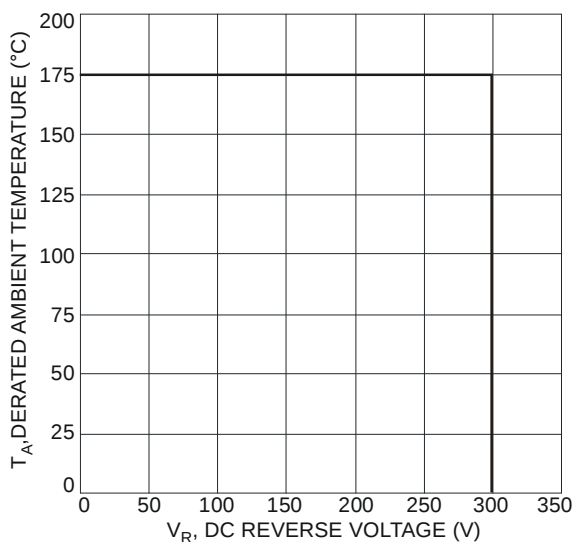
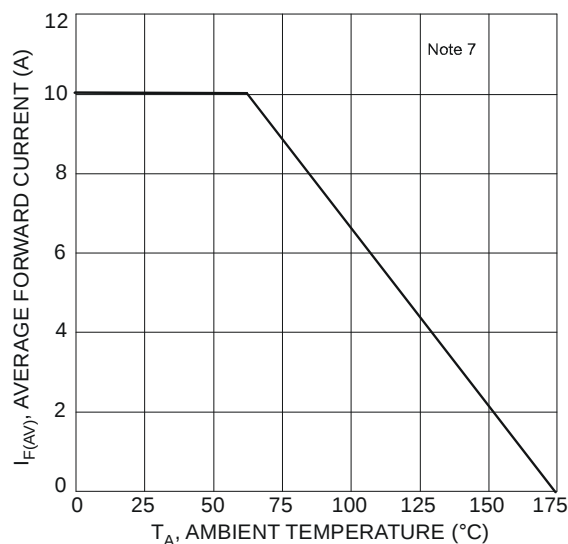
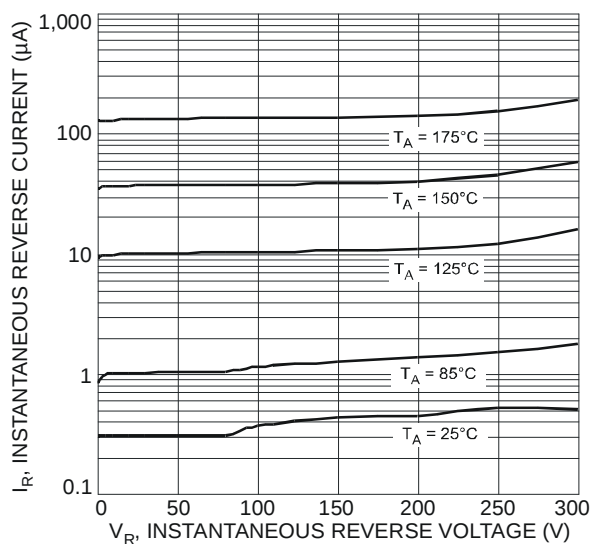
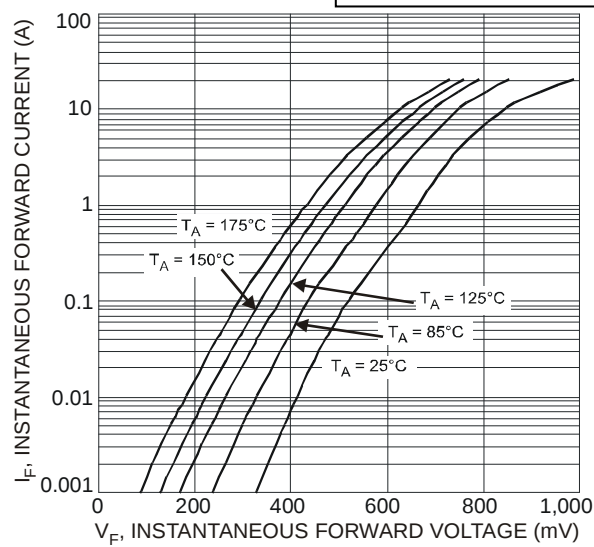
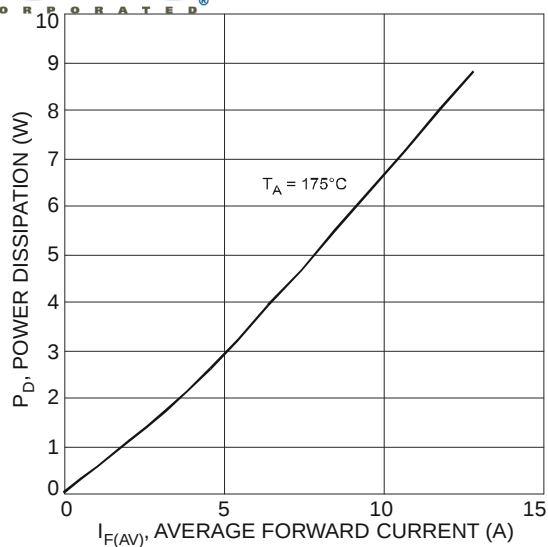
Thermal Characteristics (Per Leg)

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance (Note 7) Package = TO-220AB Package = ITO-220AB Package = TO263AB (D ² Pak)	R _{θJC}	2 4 2	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +175	°C

Electrical Characteristics (Per Leg) (@T_A = +25°C, unless otherwise specified.)

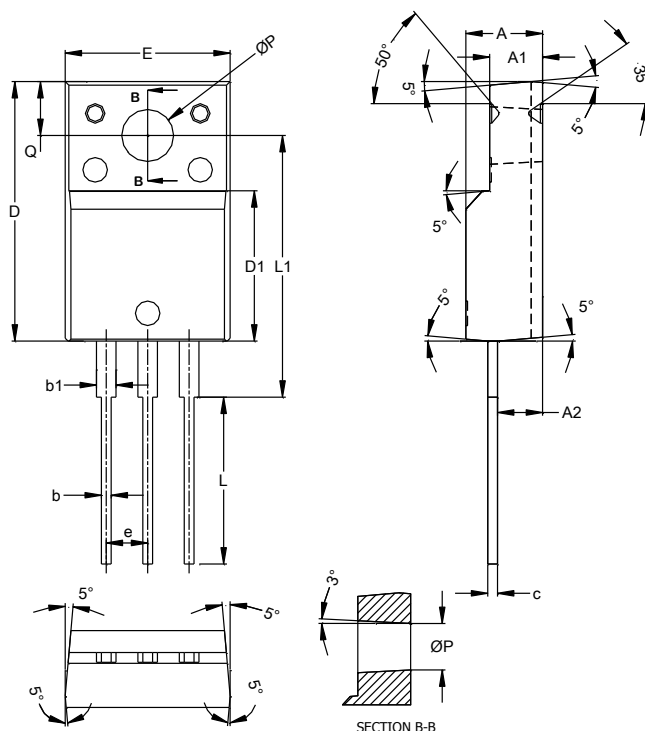
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	— 0.70 —	0.92 0.78 1.06	V	I _F = 10A, T _J = +25°C I _F = 10A, T _J = +125°C I _F = 20A, T _J = +25°C
Leakage Current (Note 6)	I _R	—	—	0.1 10	mA	V _R = 300V, T _J = +25°C V _R = 300V, T _J = +125°C
Reverse Recovery Time	T _{rr}	—	45	—	ns	I _F = 0.5A, I _R = 1A, I _{RR} = 0.25A

Notes: 6. Short duration pulse test used to minimize self-heating effect.
 7. Using 50mm x 50mm x 23mm Al heatsink.

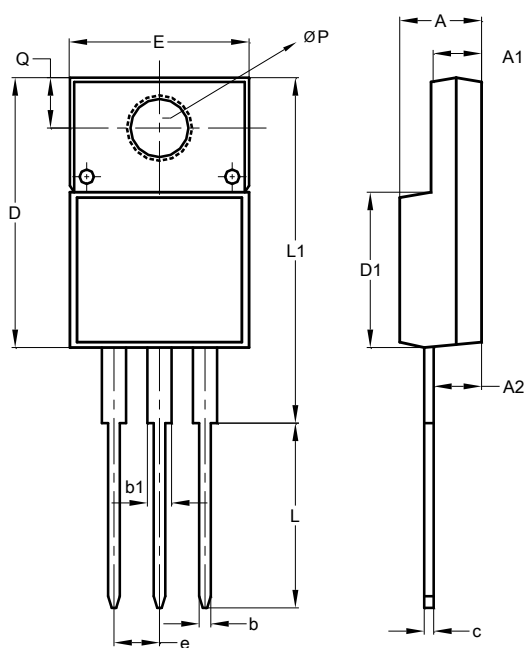


Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



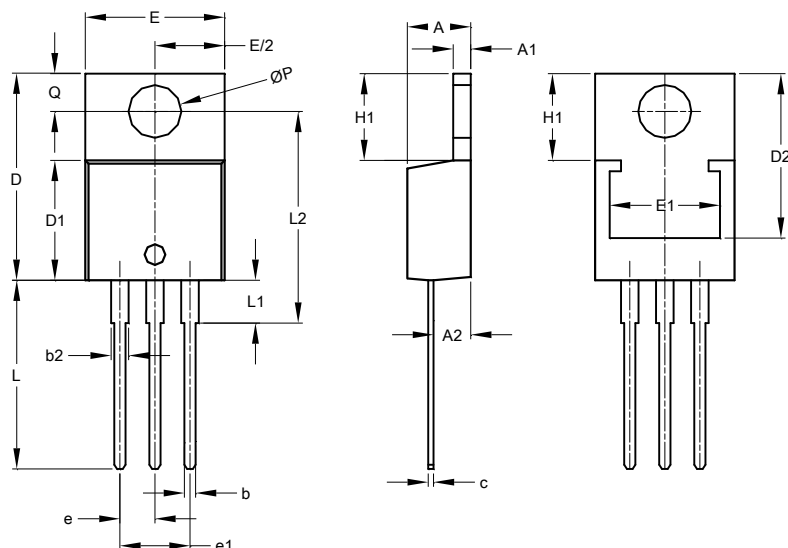
ITO220AB			
Dim	Min	Max	Typ
A	4.50	4.90	4.70
A1	3.04	3.44	3.24
A2	2.56	2.96	2.76
b	0.50	0.75	0.60
b1	1.10	1.35	1.20
c	0.50	0.70	0.60
D	15.67	16.07	15.87
D1	8.99	9.39	9.19
E	9.91	10.31	10.11
e	--	--	2.54
L	9.45	10.05	9.75
L1	15.80	16.20	16.00
P	2.98	3.38	3.18
Q	3.10	3.50	3.30
All Dimensions in mm			



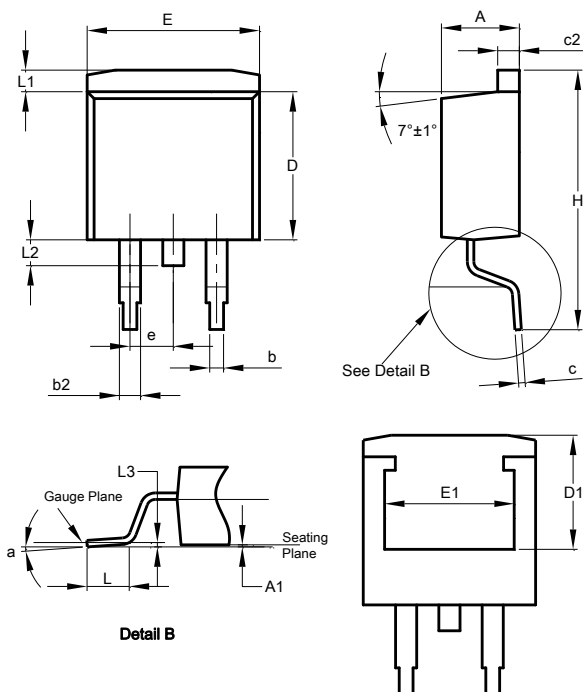
ITO220AB (Type E)		
Dim	Min	Max
A	4.36	4.77
A1	2.54	3.10
A2	2.54	2.80
b	0.55	0.75
b1	1.20	1.50
c	0.38	0.68
D	14.50	15.50
D1	8.38	8.89
e	2.41	2.67
E	9.72	10.27
L	9.87	10.67
L1	15.8	17.00
P	3.08	3.39
Q	2.60	3.00
All Dimensions in mm		

Package Outline Dimensions (Cont.)

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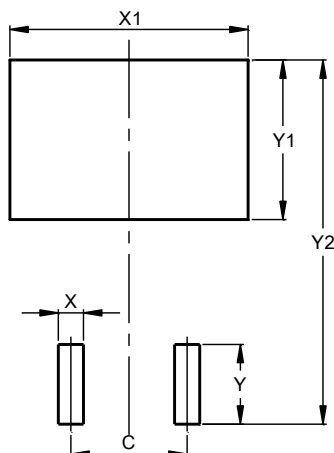
TO220AB			
Dim	Min	Max	Typ
A	3.56	4.82	-
A1	0.51	1.39	-
A2	2.04	2.92	-
b	0.39	1.01	0.81
b2	1.15	1.77	1.24
c	0.356	0.61	-
D	14.22	16.51	-
D1	8.39	9.01	-
D2	11.45	12.87	-
e	-	-	2.54
e1	-	-	5.08
E	9.66	10.66	-
E1	6.86	8.89	-
H1	5.85	6.85	-
L	12.70	14.73	-
L1	-	6.35	-
L2	15.80	16.20	16.00
P	3.54	4.08	-
Q	2.54	3.42	-
All Dimensions in mm			



TO263AB (D2PAK)			
Dim	Min	Max	Typ
A	4.07	4.82	-
A1	0.00	0.25	-
b	0.51	0.99	-
b2	1.15	1.77	-
c	0.356	0.73	-
c2	1.143	1.65	-
D	8.39	9.65	-
D1	6.55	6.95	-
e	2.54 TYP		
E	9.66	10.66	-
E1	6.23	8.23	-
H	14.61	15.87	-
L	1.78	2.79	-
L1	-	1.67	-
L2	-	1.77	-
L3	-	-	0.254
a	0°	8°	-
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	5.08
X	1.10
X1	10.41
Y	3.50
Y1	7.01
Y2	15.99

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